

Certificate of Analysis (CoA)

Aug. 9, 2025

Product Name: Hafnium Oxide Sputtering Target**Chemical Formula:** HfO₂**Purity:** 99.99% (4N)**Target Dimensions:** Ø76.2 mm × 3.18 mm (Ø3" × 1/8")**Backing Plate:** Elastomer bonded to Copper plate, Ø76.2 mm × 2.54 mm**Keeper:** Magnetic keeper, Ø31.25 mm × 1.52 mm**Lot Number:** CSXK-25SC-5105TB**Manufactured by:** Thin-Film Materials**Physical Description**

- Form: Ceramic sputtering target
- Appearance: White to off-white dense solid
- Crystal Structure: Monoclinic (room temperature phase)
- Theoretical Density: ~9.68 g/cm³
- Fabrication: Hot pressing followed by precision machining, elastomer bonding to copper backing plate, magnetic keeper attached

Theoretical Composition (Stoichiometric Mass %)**Element Symbol Mass %**

Hafnium Hf ~77.3%

Oxygen O ~22.7%

Chemical Composition (by ICP-OES / GDMS)

Element	Symbol	Max. Content (ppm)
Hafnium Oxide	HfO ₂	Balance (>99.99%)
Zirconium	Zr	<100
Iron	Fe	<10
Silicon	Si	<10
Aluminum	Al	<10
Calcium	Ca	<10

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Element	Symbol	Max. Content (ppm)
Other metals (each) –		<10
Total Impurities –		<100 ppm

Handling & Storage

- Store in vacuum-sealed or inert gas packaging.
 - Avoid impact to prevent cracking of the ceramic target.
 - Handle with clean gloves to prevent surface contamination.
 - Keep magnetic keeper attached when not in use to protect bonding interface.
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Declaration

We certify that the above product has been manufactured and tested in accordance with our quality management procedures and meets the specifications stated herein.

Authorized Signature:Inspection Certificate by: Nancy LiuApprover by: Chen Qiang